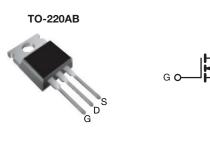
## SiHP22N60E





## **E Series Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650				
R <sub>DS(on)</sub> max. at 25 °C (Ω)	V <sub>GS</sub> = 10 V 0.18				
Q <sub>g</sub> max. (nC)	86				
Q <sub>gs</sub> (nC)	11				
Q <sub>gd</sub> (nC)	24				
Configuration	Single				



S N-Channel MOSFET

### **FEATURES**

- Low Figure-of-Merit (FOM) Ron x Qg
- Low Input Capacitance (Ciss)
- Reduced Switching and Conduction Losses
- Ultra Low Gate Charge (Qg)
- Avalanche Energy Rated (UIS)
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- Server and Telecom Power Supplies
- Switch Mode Power Supplies (SMPS)
- Power Factor Correction Power Supplies (PFC)
- Lighting
  - High-Intensity Discharge (HID)
  - Fluorescent Ballast Lighting
- Industrial
  - Welding
  - Induction Heating
  - Motor Drives
  - Battery Chargers
  - Renewable Energy
  - Solar (PV Inverters)

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	SiHP22N60E-E3		
Lead (Pb)-free and Halogen-free	SiHP22N60E-GE3		

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V <sub>DS</sub>	600			
Gate-Source Voltage	N	± 20	V		
Gate-Source Voltage AC (f > 1 Hz)	V <sub>GS</sub>	30			
Continuous Drain Current (T. 150 °C)	$V_{GS} \text{ at } 10 \text{ V} \qquad T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	- I <sub>D</sub>	21		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	$V_{GS}$ at 10 V $T_{C} = 100 \text{ °C}$		13	А	
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	56			
Linear Derating Factor		1.8	W/°C		
Single Pulse Avalanche Energy <sup>b</sup>	E <sub>AS</sub>	367	mJ		
Maximum Power Dissipation	PD	227	W		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-Source Voltage Slope $T_J = 125 \text{ °C}$		dV/dt	37	V/ns	
Reverse Diode dV/dt <sup>d</sup>			11		
Soldering Recommendations (Peak Temperature) <sup>c</sup> for 10 s			300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 5.1 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D,\,dI/dt$  = 100 A/µs, starting  $T_J$  = 25 °C.

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RoHS

COMPLIANT

HALOGEN



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THERMAL RESISTANCE RATII	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		62		*C AN		
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	- 0.55			°C/W		
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 $^{\circ}$ C, u	nless otherwi	ise noted)						
PARAMETER	SYMBOL	TEST	r condit	IONS	MIN.	TYP.	MAX.	UNI
Static		*						-
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> =	250 µA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	to 25 °C,	I <sub>D</sub> = 250 μA	-	0.71	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> =	250 µA	2	-	4	V
Gate-Source Leakage	I <sub>GSS</sub>	,	$V_{GS} = \pm 20$	V	-	-	± 100	nA
	000		600 V, V <sub>0</sub>		-	-	1	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	-		V, T <sub>J</sub> = 125 °C	-	-	10	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		<sub>D</sub> = 11 A	-	0.15	0.18	Ω
Forward Transconductance	g <sub>fs</sub>		<sub>s</sub> = 8 V, I <sub>D</sub>	= 5 A	-	6.4	-	S
Dynamic			<u> </u>		1		L	
Input Capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 \	/	-	1920	-	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 100 V,$		-	90	-	1	
Reverse Transfer Capacitance	C <sub>rss</sub>		f = 1 MH	z	-	6	-	
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>	- V <sub>DS</sub> = 0 V to 480 V, V <sub>GS</sub> = 0 V		-	73	-	pF	
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>			-	263	-		
Total Gate Charge	Qg				-	57	86	
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	V <sub>GS</sub> = 10 V I <sub>D</sub> = 11 A, V <sub>DS</sub> = 480 V		-	11	-	nC
Gate-Drain Charge	Q <sub>gd</sub>				-	24	-	1
Turn-On Delay Time	t <sub>d(on)</sub>				-	18	36	
Rise Time	t <sub>r</sub>	V=	: 380 V, I <sub>D</sub>	= 11 A.	-	27	54	ns
Turn-Off Delay Time	t <sub>d(off)</sub>		= 10 V, R <sub>g</sub>		-	66	99	
Fall Time	t <sub>f</sub>	1		-	35	70		
Gate Input Resistance	R <sub>g</sub>	f = 1	MHz, ope	n drain	-	0.77	-	Ω
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	21		
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	56	A	
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 11 A, V <sub>GS</sub> = 0 V		-	-	1.2	V	
Reverse Recovery Time	t <sub>rr</sub>				-	344	-	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$T_{\rm J}$ = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 11 A, dI/dt = 100 A/µs, V <sub>R</sub> = 25 V		-	5.3	-	μC	
Reverse Recovery Current	I <sub>RRM</sub>			_	28	_	A	

### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ . b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .



## SiHP22N60E

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

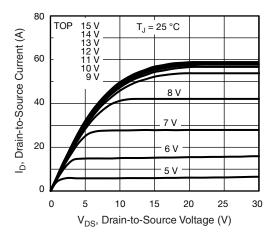


Fig. 1 - Typical Output Characteristics

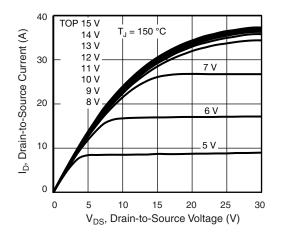
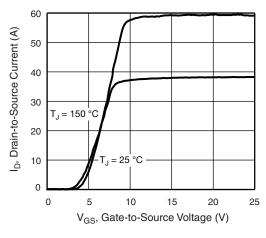


Fig. 2 - Typical Output Characteristics





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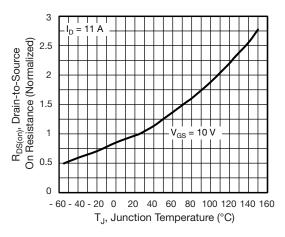


Fig. 4 - Normalized On-Resistance vs. Temperature

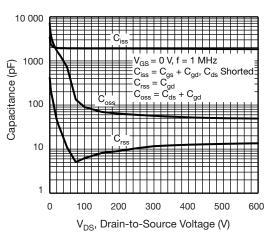
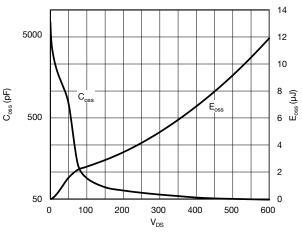


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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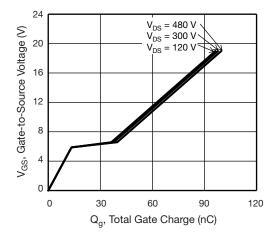


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

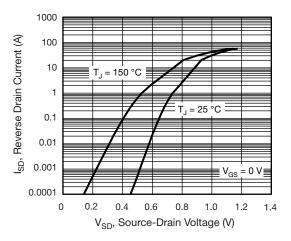


Fig. 8 - Typical Source-Drain Diode Forward Voltage

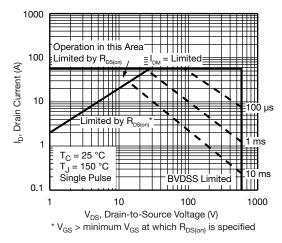


Fig. 9 - Maximum Safe Operating Area

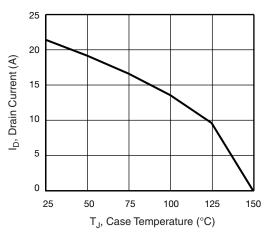


Fig. 10 - Maximum Drain Current vs. Case Temperature

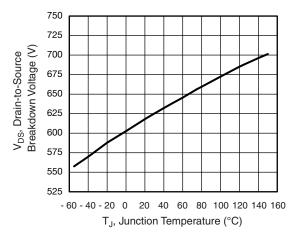
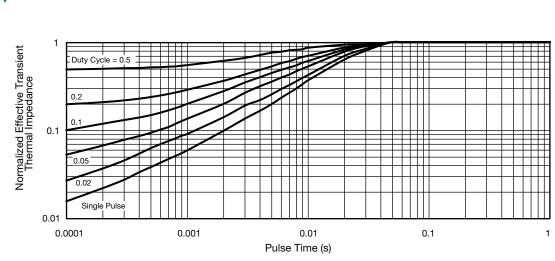
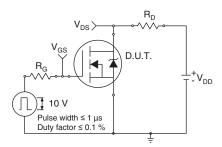


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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Fig. 13 - Switching Time Test Circuit

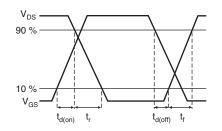


Fig. 14 - Switching Time Waveforms

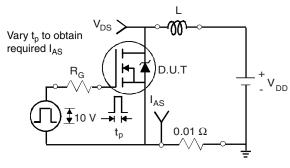


Fig. 15 - Unclamped Inductive Test Circuit

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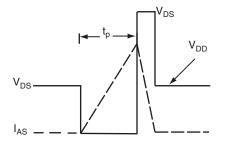


Fig. 16 - Unclamped Inductive Waveforms

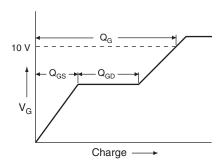


Fig. 17 - Basic Gate Charge Waveform

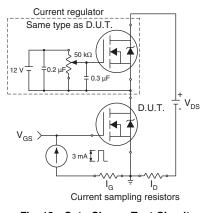


Fig. 18 - Gate Charge Test Circuit

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### Peak Diode Recovery dV/dt Test Circuit

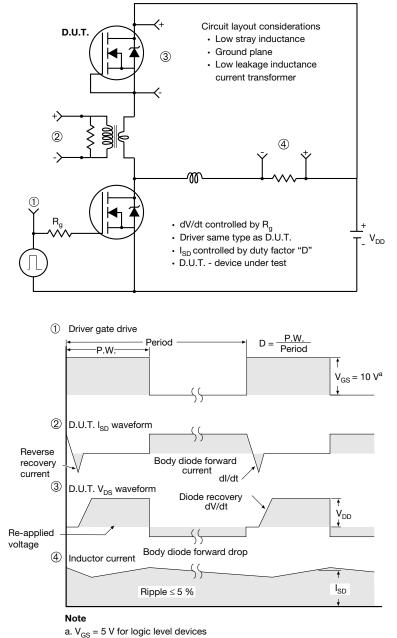


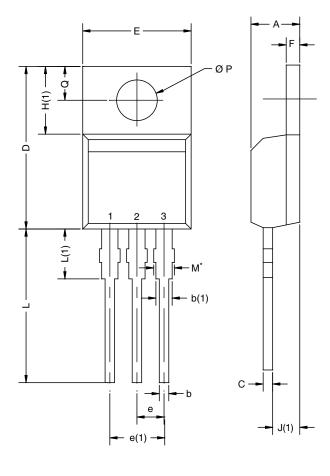
Fig. 19 - For N-Channel

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## **TO-220AB**



	MILLIN	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
E	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØР	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118
ECN: T13- DWG: 547	0724-Rev. O, 1	14-Oct-13		

#### Note

\* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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